Kingbright

WP36BHD

T-1 (3mm) Blinking LED Lamp

DESCRIPTIONS

- The Bright Red source color devices are made with Gallium Phosphide Red Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-Electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- T-1 package with rectangular base
- With built-in blinking IC
- Operation voltage from 3.5V to 14V
- Blinking frequency from 3.0Hz to 1.5Hz
- RoHS compliant

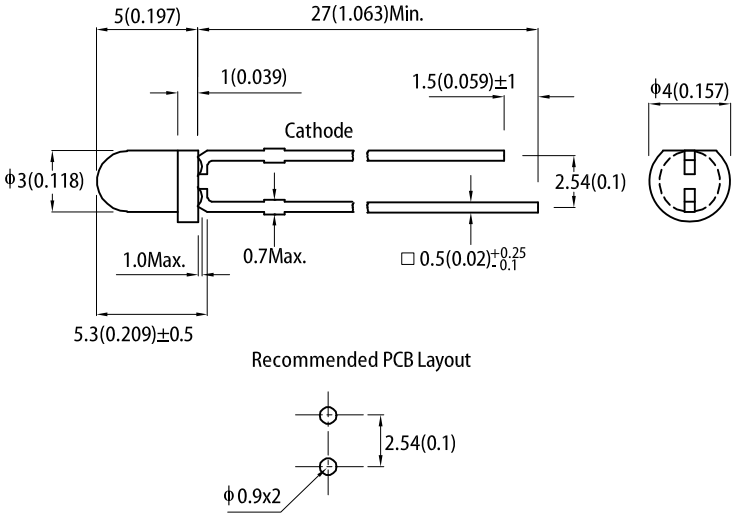
APPLICATIONS

- Status indicator
- Illuminator
- Signage applications
- Decorative and entertainment lighting
- Commercial and residential architectural lighting

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

PACKAGE DIMENSIONS



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25(0.01") unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) V = 9V		Viewing Angle [1]
			Min.	Typ.	2θ1/2
WP36BHD	Bright Red (GaP)	Red Diffused	0.6	1.8	60°

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity value is traceable to CIE127-2007 standards.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value			Unit
			Min.	Typ.	Max.	
Peak Wavelength	λ_{peak}	Bright Red	-	700	-	nm
Dominant Wavelength	λ_{dom} [1]	Bright Red	-	635	-	nm
Spectral Bandwidth at 50% Φ REL MAX	Δλ	Bright Red	-	45	-	nm
Forward Current Min: V_F = 3.5V Typ: V_F = 5V	I_F	Bright Red	8	22	-	mA
Supply Current V_F = 3.5V	ISON	Bright Red	-	8	-	mA
Supply Current V_F = 14V	ISON	Bright Red	-	44	-	mA
Blink Frequency V_F = 3.5V~14V	f	Bright Red	1.5	-	3	Hz

Notes:
1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
2. Wavelength value is traceable to CIE127-2007 standards.
3. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P_D	310	mW
Reverse Voltage	V_R	0.5	V
Junction Temperature	T_j	125	°C
Operating Temperature	T_{op}	-40 to +70	°C
Storage Temperature	T_{stg}	-40 to +85	°C
Forward Voltage	V_F	14	V
Electrostatic Discharge Threshold (HBM)	-	1000	V
Lead Solder Temperature [1]		260°C For 3 Seconds	
Lead Solder Temperature [2]		260°C For 5 Seconds	

Notes:
1. 2mm below package base.
2. 5mm below package base.
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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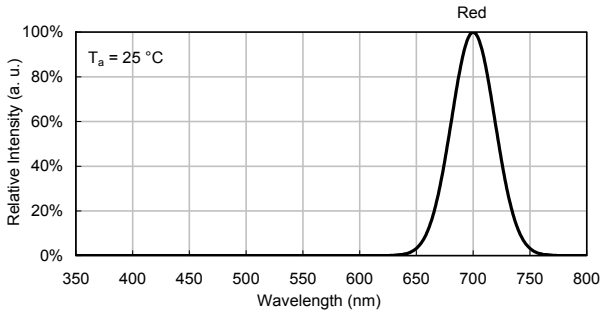
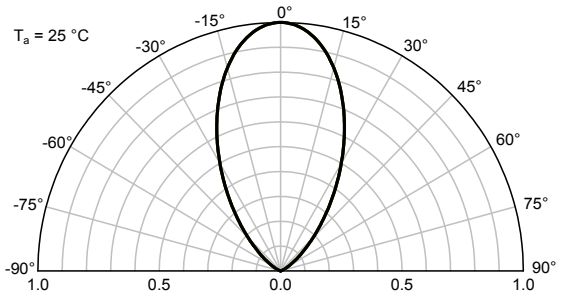
TECHNICAL DATA

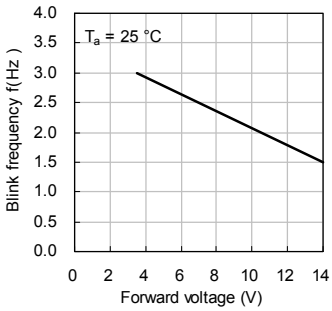
RELATIVE INTENSITY vs. WAVELENGTH

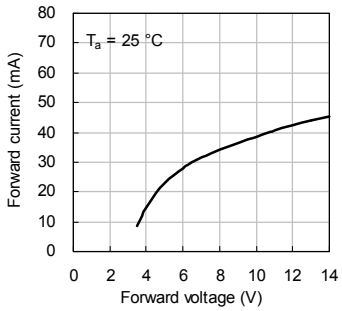


SPATIAL DISTRIBUTION

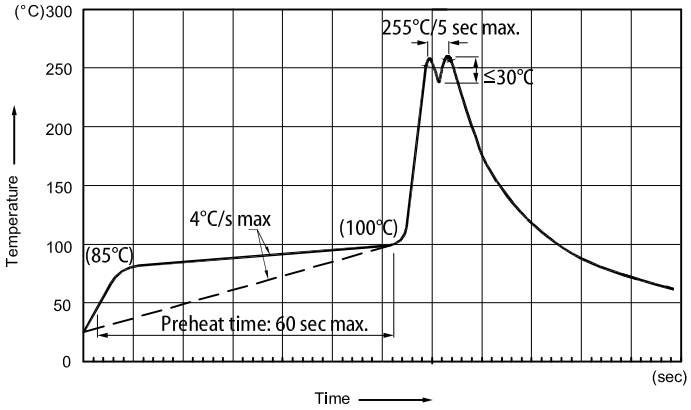


BRIGHE RED



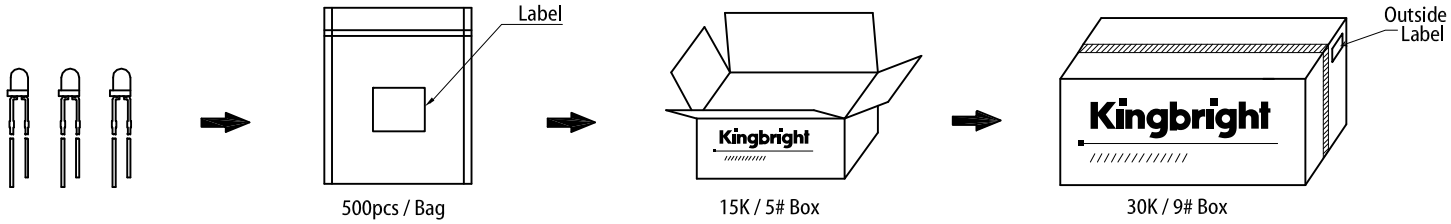


RECOMMENDED WAVE SOLDERING PROFILE



Notes:
1. *Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C*
2. *Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).*
3. *Do not apply stress to the epoxy resin while the temperature is above 85°C.*
4. *Fixtures should not incur stress on the component when mounting and during soldering process.*
5. *SAC 305 solder alloy is recommended.*
6. *No more than one wave soldering pass.*

PACKING & LABEL SPECIFICATIONS



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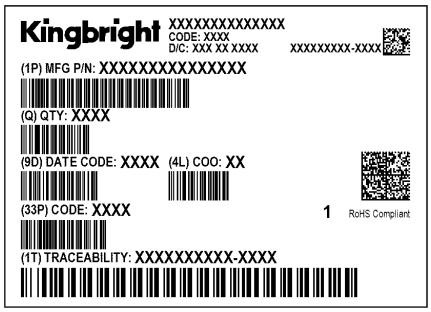


PRECAUTIONS

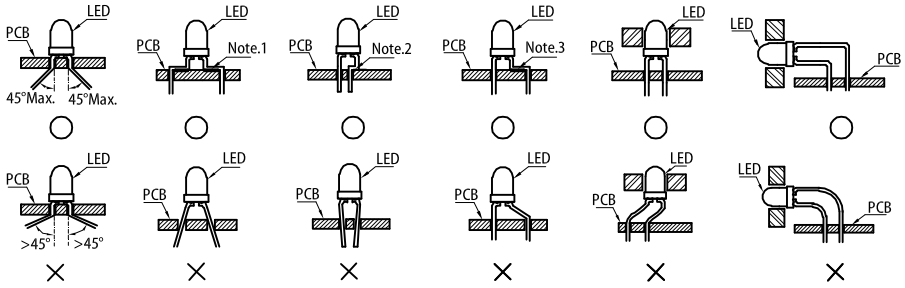
Storage conditions

1. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
2. LEDs should be stored with temperature ≤ 30°C and relative humidity < 60%.
3. Product in the original sealed package is recommended to be assembled within 72 hours of opening.
   Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.

LED Mounting Method

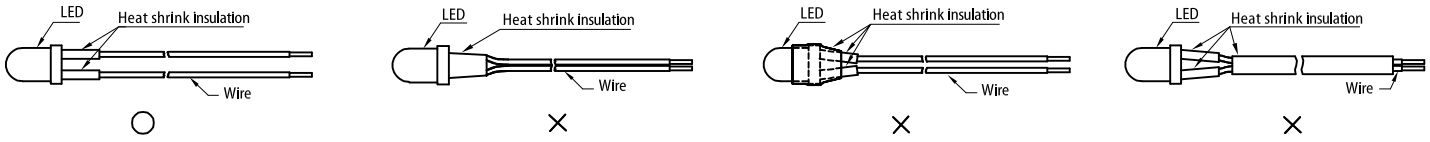
1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement.
   Lead-forming may be required to insure the lead pitch matches the hole pitch.
   Refer to the figure below for proper lead forming procedures.

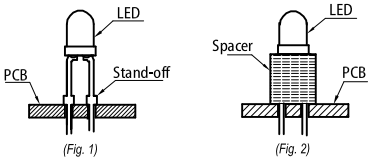
Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.



" ○ " *Correct mounting method* " x " *Incorrect mounting method*

2. When soldering wires to the LED, each wire joint should be separately insulated with heat-shrink tube to prevent short-circuit contact. Do not bundle both wires in one heat shrink tube to avoid pinching the LED leads. Pinching stress on the LED leads may damage the internal structures and cause failure.





3. Use stand-offs *(Fig.1)* or spacers *(Fig.2)* to securely position the LED above the PCB.
4. Maintain a minimum of 3mm clearance between the base of the LED lens and the first lead bend *(Fig. 3 ,Fig. 4)*.
5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. *(Fig. 5)*

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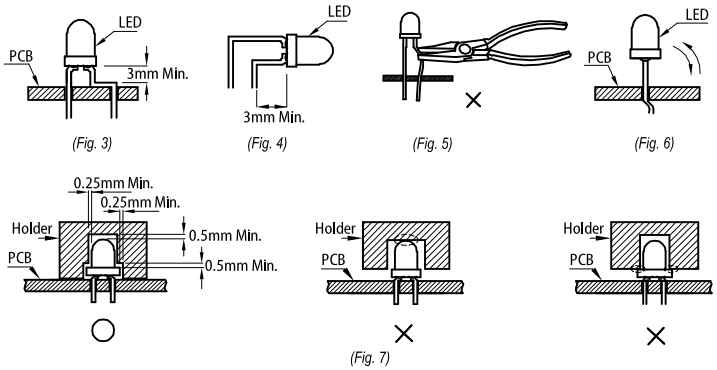
Lead Forming Procedures

1. Do not bend the leads more than twice. *(Fig. 6)*
2. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering. *(Fig. 7)*
3. The tip of the soldering iron should never touch the lens epoxy.
4. Through-hole LEDs are incompatible with reflow soldering.
5. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.



PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
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